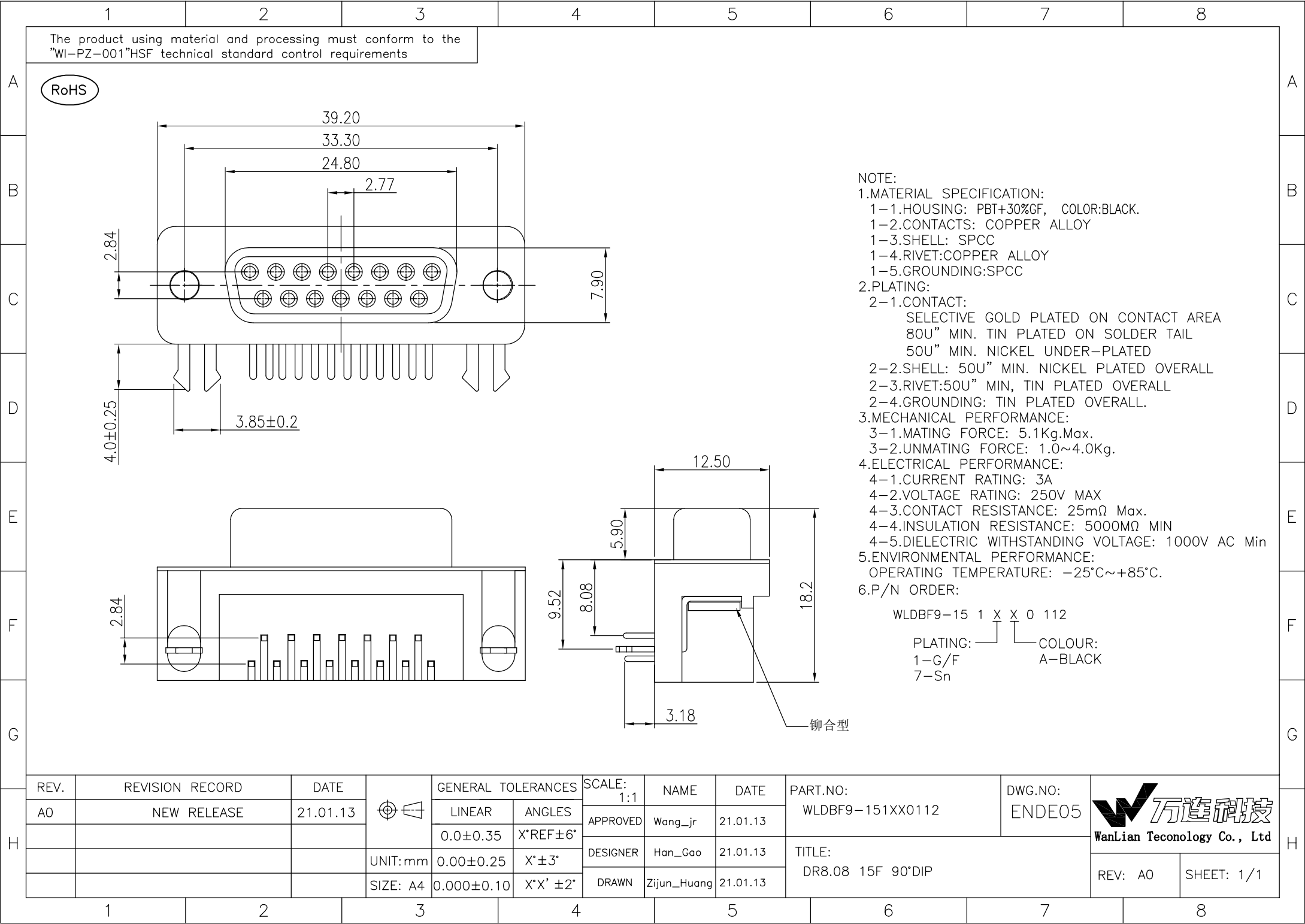




The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

RoHS

NOTE:
1.MATERIAL SPECIFICATION:
1-1.HOUSING: PBT+30%GF, COLOR:BLACK.
1-2.CONTACTS: COPPER ALLOY
1-3.SHELL: SPCC
1-4.RIVET:COPPER ALLOY
1-5.GROUNDING:SPCC
2.PLATING:
2-1.CONTACT:
SELECTIVE GOLD PLATED ON CONTACT AREA
80U" MIN. TIN PLATED ON SOLDER TAIL
50U" MIN. NICKEL UNDER-PLATED
2-2.SHELL: 50U" MIN. NICKEL PLATED OVERALL
2-3.RIVET:50U" MIN, TIN PLATED OVERALL
2-4.GROUNDING: TIN PLATED OVERALL.
3.MECHANICAL PERFORMANCE:
3-1.MATING FORCE: 5.1Kg.Max.
3-2.UNMATING FORCE: 1.0~4.0Kg.
4.ELECTRICAL PERFORMANCE:
4-1.CURRENT RATING: 3A
4-2.VOLTAGE RATING: 250V MAX
4-3.CONTACT RESISTANCE: 25mΩ Max.
4-4.INSULATION RESISTANCE: 5000MΩ MIN
4-5.DIELECTRIC WITHSTANDING VOLTAGE: 1000V AC Min
5.ENVIRONMENTAL PERFORMANCE:
OPERATING TEMPERATURE: -25°C~+85°C.
6.P/N ORDER:
WLDBF9-15 1 X X 0 112
PLATING: 1-G/F COLOUR: A-BLACK
7-Sn

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: WLDBF9-151XX0112	DWG.NO: ENDE05		
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13				
				0.0±0.35	X*REF±6°							
				UNIT:mm	0.00±0.25	X*±3°	DESIGNER	Han_Gao	21.01.13	TITLE: DR8.08 15F 90°DIP		REV: A0
			SIZE: A4	0.000±0.10	X*X' ±2°	DRAWN	Zijun_Huang	21.01.13				